

Title (en)  
SPUTTERING SURFACE TREATMENT FOR ACTIVE FILTER

Title (de)  
SPUTTER-OBERFLÄCHENBEHANDLUNG FÜR AKTIVE FILTER

Title (fr)  
TRAITEMENT SURFACIQUE PAR PULVÉRISATION CATHODIQUE POUR FILTRE ACTIF

Publication  
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Application  
**EP 20848804 A 20201217**

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Abstract (en)  
[origin: WO2021123640A1] The invention relates to a method of surface treatment in order to constitute an active filter (21) for a reactive compound of a gas mixture, the method comprising a step of depositing at least one layer of an absorbing material on the surface of a support, the deposition step being carried out by sputtering of an electrode (7) comprising at least one absorbing material chosen to react with the reactive compound of the gas mixture.

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